

Features:

- Isolated mounting base 4000V~
- Pressure contact technology with increased power cycling capability
- Space and weight saving

Typical Applications

- AC/DC Motor drives
- Various rectifiers
- DC supply for PWM inverter

V _{DSM} ,V _{RSM}	V _{DRM} ,V _{RRM}	Type & Outline
2700V	2600V	MTx600-26-411F3
2900V	2800V	MTx600-28-411F3
3100 V	3000 V	MTx600-30-411F3
3300 V	3200 V	MTx600-32-411F3
3500 V	3400 V	MTx600-34-411F3
3700 V	3600 V	MTx600-36-411F3

SYMBOL	CHARACTERISTIC	TEST CONDITIONS	T _j (°C)	VALUE			UNIT
				Min	Type	Max	
I _{T(AV)}	Mean on-state current	180° half sine wave 50Hz Single side cooled, T _c =55°C	125			600	A
I _{T(RMS)}	RMS on-state current					942	A
I _{DRM} I _{RRM}	Repetitive peak current	at V _{DRM} at V _{RRM}	125			55	mA
I _{TSM}	Surge on-state current	10ms half sine wave V _R =60%V _{RRM}	125			14.0	kA
I ² t	I ² t for fusing coordination					980	A ² s*10 ³
V _{TO}	Threshold voltage		125			1.02	V
r _T	On-state slope resistance					0.95	mΩ
V _{TM}	Peak on-state voltage	I _{TM} =1800A	25			2.95	V
dv/dt	Critical rate of rise of off-state voltage	V _{DM} =67%V _{DRM}	125			800	V/μs
di/dt	Critical rate of rise of on-state current	Gate source 1.5A t _r ≤ 0.5μs Repetitive	125			100	A/μs
I _{GT}	Gate trigger current	V _A =12V, I _A =1A	25	30		200	mA
V _{GT}	Gate trigger voltage			0.8		3.0	V
I _H	Holding current			10		200	mA
V _{GD}	Non-trigger gate voltage	V _{DM} =67%V _{DRM}	125	0.2			V
R _{th(j-c)}	Thermal resistance Junction to case	Single side cooled per chip				0.048	°C/W
R _{th(c-h)}	Thermal resistance case to heat sink	Single side cooled per chip				0.024	°C/W
V _{iso}	Isolation voltage	50Hz,R.M.S,t=1min,I _{iso} :1mA(MAX)		4000			V
F _m	Terminal connection torque(M12)				14.0		N·m
	Mounting torque(M8)				12.0		N·m
T _{vj}	Junction temperature			-40		125	°C
T _{stg}	Stored temperature			-40		125	°C
W _t	Weight				3460		g
Outline	411F3						

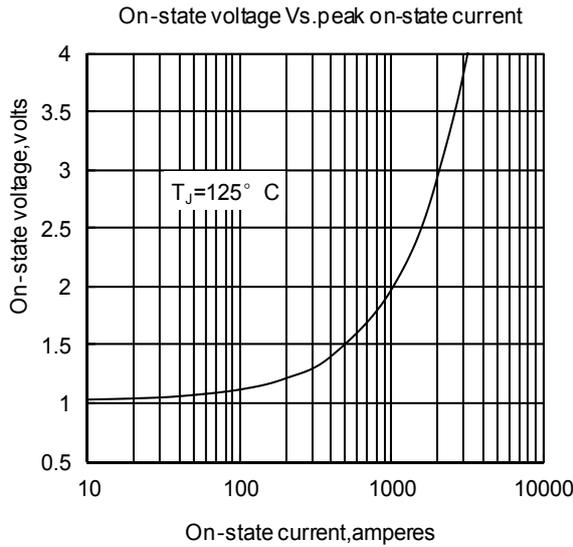


Fig1

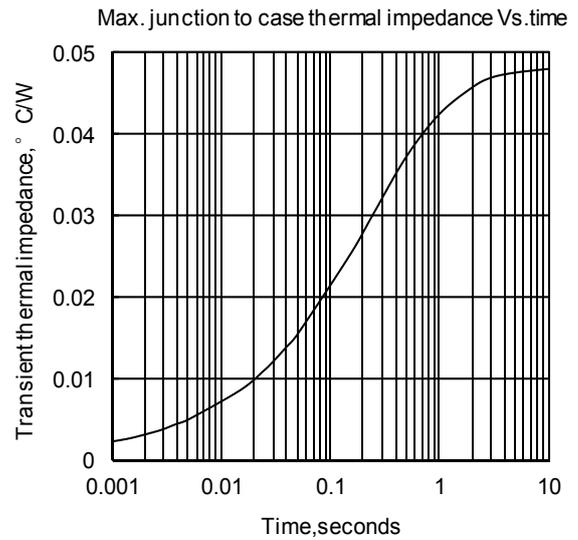


Fig2

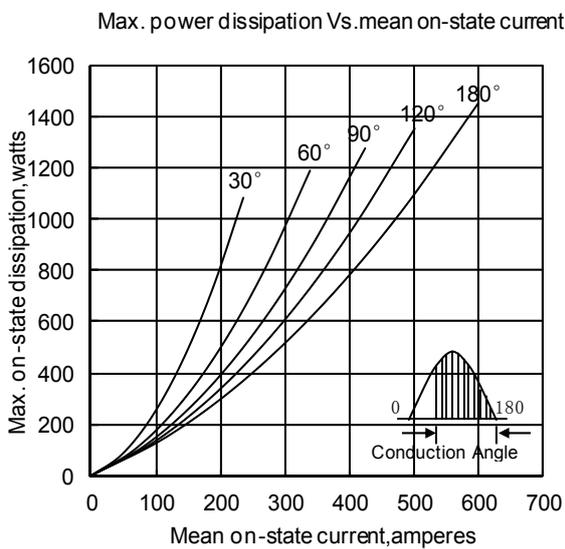


Fig3

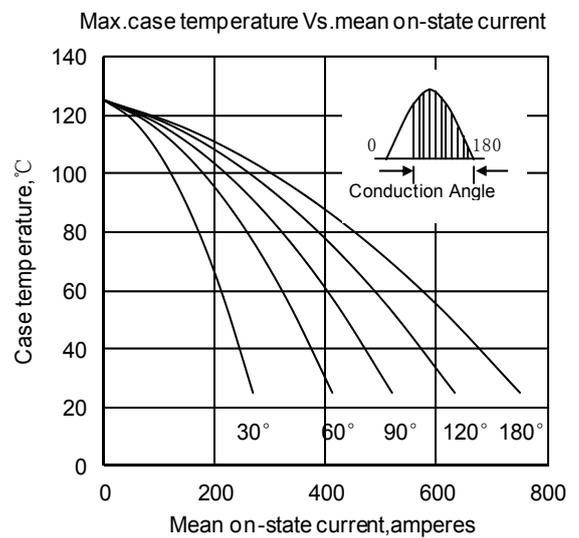


Fig4

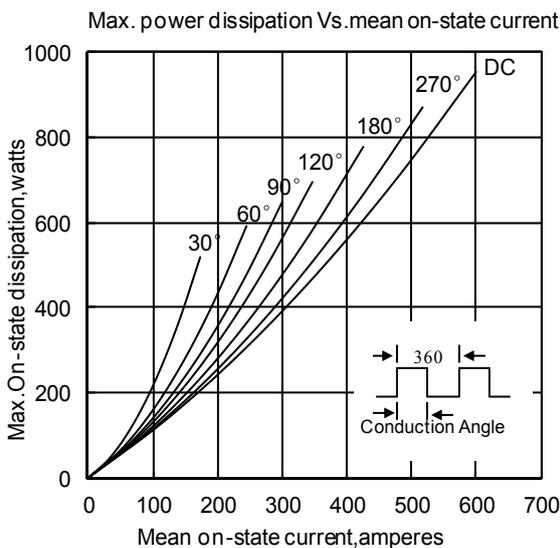


Fig5

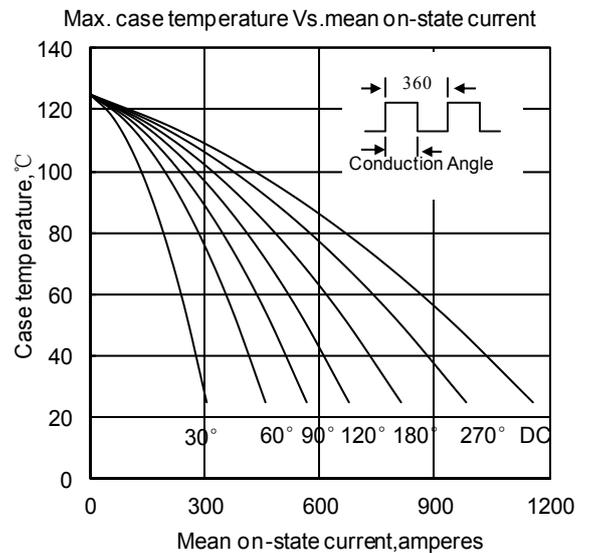


Fig6

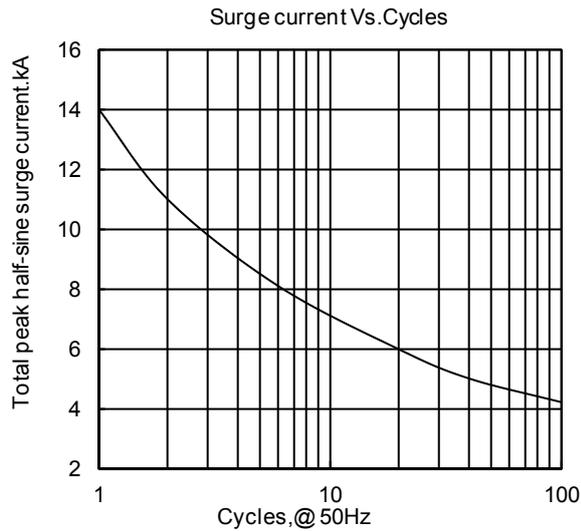


Fig7

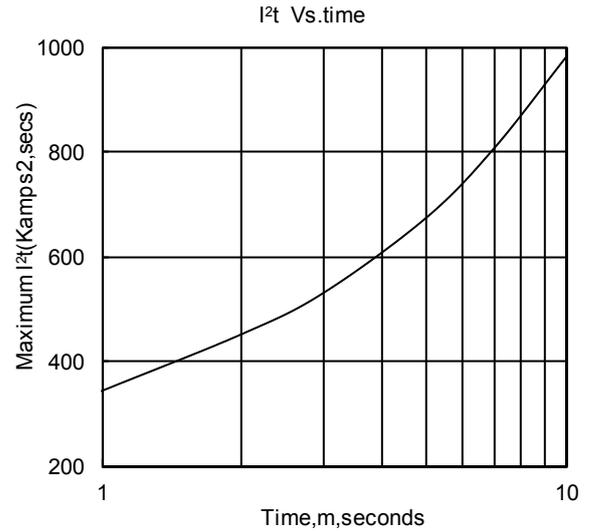


Fig8

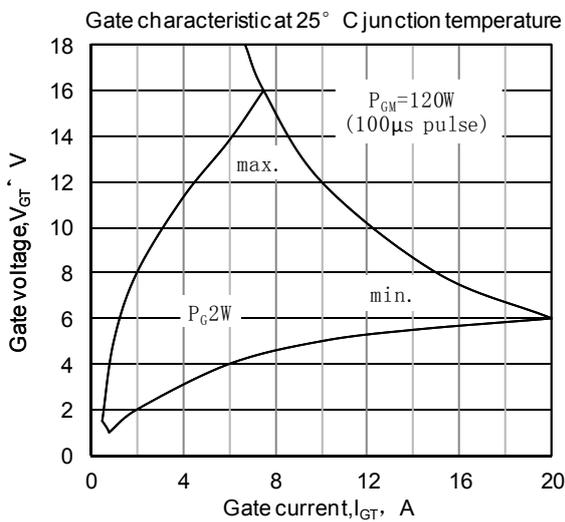


Fig9

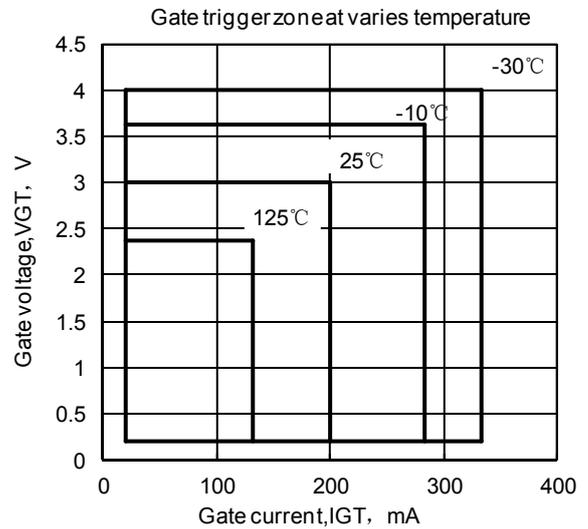
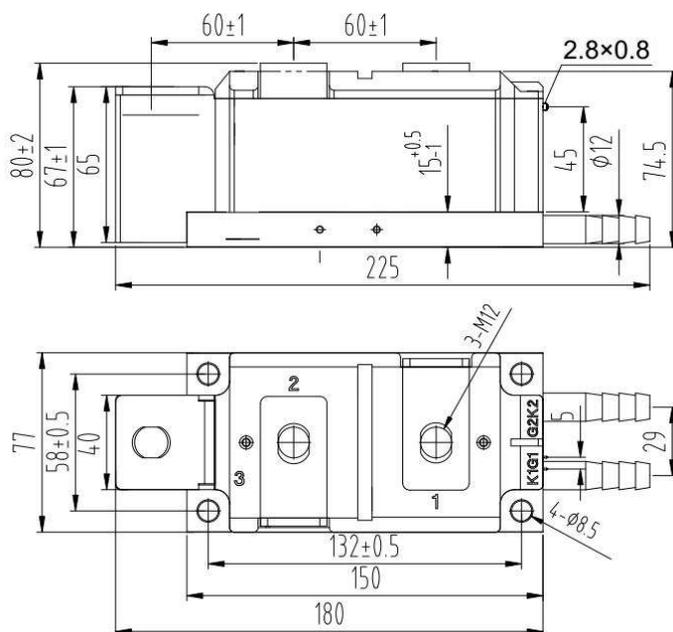
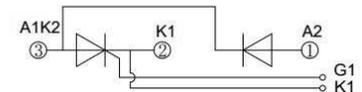


Fig10

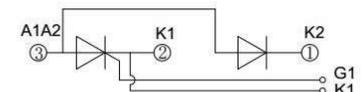
Outline:



MFC (TD)



MFA (TD)



MFK (TD)

